

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

	-			
Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	IPP	2.0	А	8/20µs (Note 7)
ESD Protection – Contact Discharge	V _{ESD} Contact	±12	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD_Air}	±15	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	300	mW
Thermal Resistance, Junction to Ambient $T_A = +25^{\circ}C$	R _{0JA}	417	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V _{RWM}	_	_	5.5	V	—
Channel Leakage Current (Note 6)	I _R	—	—	100	nA	V _R = 5V, Any I/O to GND
Reverse breakdown voltage	V _{BR}	6.0	_	_	V	I _R = 1mA
Forward voltage	VF	—	0.85	—	V	I _F = 4mA
Clamping Voltage, Positive Transients (Note 7)	Vc	_	9.5	11.5	V	I _{PP} = 1A, t _p = 8/20μs
		_	10.5	12.5		I _{PP} = 2A, t _p = 8/20μs
Channel Input Capacitance (Note 8)	CT	-	0.5	_	рF	V _R = 0V, f = 1MHz, Any I/O to GND
		_	0.4	0.65		V _R = 2.5V, f = 1MHz, Any I/O to GND
Dynamic Resistance	R _{DYN}	_	0.9	_	Ω	I _{PP} = 1A, t _p = 8/20μs

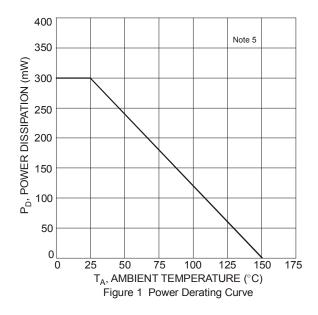
Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.

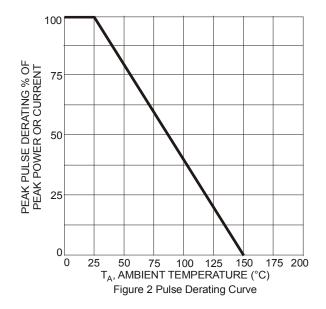
6. Short duration pulse test used to minimize self-heating effect.

7. Clamping voltage value is based on an $8x20\mu$ s peak pulse current (I_{pp}) waveform.

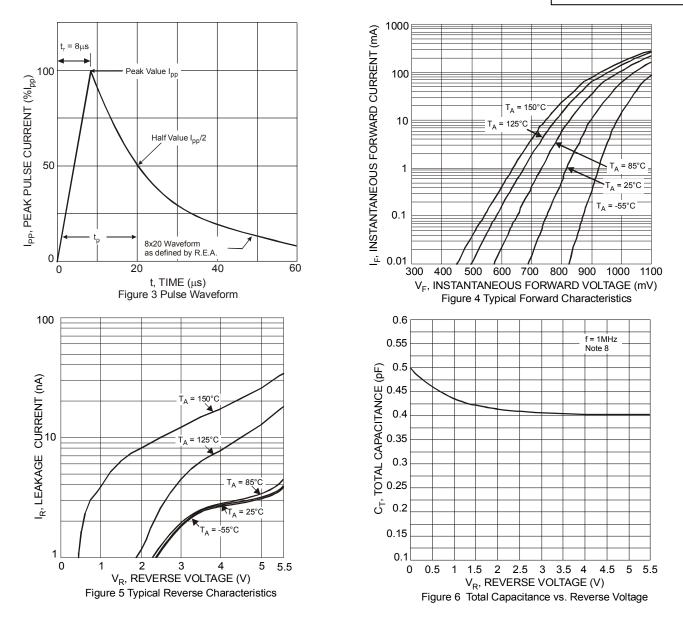
8. Measured from any I/O to GND.

9. For information on the impact of Diodes' USB 2.0 compatible ESD protectors on signal integrity including eye diagram plots, please refer to AN77 at the following URL: http://www.diodes.com/destools/appnote_dnote.html.



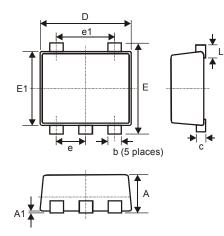






Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

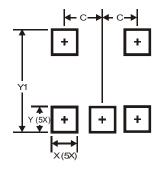


SOT953				
Dim	Min	Max	Тур	
Α	0.40	0.50	0.45	
A1	0	0.05	-	
b	0.10	0.20	0.15	
c	0.12	0.18	0.15	
D	0.95	1.05	1.00	
ш	0.95	1.05	1.00	
E1	0.75	0.85	0.80	
e	_	_	0.35	
e1	-	-	0.70	
L	0.05	0.15	0.10	
All Dimensions in mm				



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.350
Х	0.200
Y	0.200
Y1	1.100

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